

# MFBM1V1608

## Multilayer chip ferrite bead



### Product features

- 0603 (1608 metric) package
- High current handling
- Multilayer monolithic construction yields high reliability
- Impedance range from 0  $\Omega$  to 1000  $\Omega$

### Applications

- Industrial connectivity (IoT)
- Wireless communications
- Bluetooth
- WiFi
- Antennas
- Machine-to-machine (M2M)
- Mobile phones
- Wearable devices
- Wireless LAN
- Computing/gaming consoles
- Broadband components
- RF transceiver modules

### Environmental compliance and general specifications

- Operating temperature range: -55 °C to +125 °C (ambient plus self-temperature rise)



**Product specifications**

Part number <sup>3</sup>	Impedance tolerance	Impedance (Ω)	DCR (Ω) maximum @ +25 °C	Test frequency <sup>1</sup> (MHz)	Test voltage <sup>1</sup> (mV)	Rated current <sup>2</sup> (mA) maximum
MFBM1V1608-000-R	0~15 Ω	0	0.02	100	50	6000
MFBM1V1608-050-R	0~15 Ω	5	0.02	100	50	6000
MFBM1V1608-070-R	0~11 Ω	7	0.02	100	50	6000
MFBM1V1608-090-R	5~13 Ω	9	0.02	100	50	6000
MFBM1V1608-110-R	7~15 Ω	11	0.03	100	50	5000
MFBM1V1608-150-R	9~21 Ω	15	0.03	100	50	5000
MFBM1V1608-190-R	12~25 Ω	19	0.03	100	50	5000
MFBM1V1608-260-R	±25%	26	0.03	100	50	5000
MFBM1V1608-300-R	±25%	30	0.03	100	50	4000
MFBM1V1608-500-R	±25%	50	0.04	100	50	3000
MFBM1V1608-600-R	±25%	60	0.04	100	50	3000
MFBM1V1608-700-R	±25%	70	0.06	100	50	2500
MFBM1V1608-800-R	±25%	80	0.06	100	50	2500
MFBM1V1608-101-R	±25%	100	0.06	100	50	2500
MFBM1V1608-121-R	±25%	120	0.065	100	50	2000
MFBM1V1608-151-R	±25%	150	0.09	100	50	1500
MFBM1V1608-181-R	±25%	180	0.09	100	50	1500
MFBM1V1608-221-R	±25%	220	0.12	100	50	1500
MFBM1V1608-301-R	±25%	300	0.18	100	50	1500
MFBM1V1608-501-R	±25%	500	0.18	100	50	1200
MFBM1V1608-601-R	±25%	600	0.18	100	50	1200
MFBM1V1608-801-R	±25%	800	0.30	100	50	700
MFBM1V1608-102-R	±25%	1000	0.40	100	50	600

1. Impedance test frequency and voltage.

2. Rated current: Current rating for an approximate self-temperature rise of 40 °C or less.

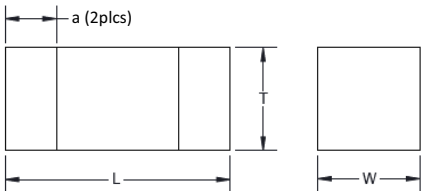
3. Part number definition: MFBM1V1608-xxx-R

MFBM1V1608 = Product code and size

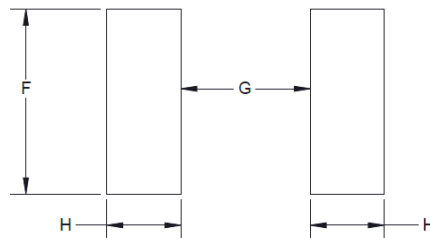
xxx = Impedance value in Ω, last character equals number of zeros

-R suffix = RoHS compliant

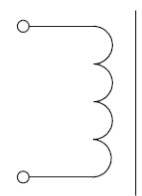
**Mechanical parameters, schematic, pad layout (mm)**



Recommended pad layout



Schematic



Part number	L	W	T	a	F	G	H
MFBM1V1608-xxx-R	1.6 ±0.2	0.80 ±0.2	0.80 ±0.2	0.30 ±0.2	1.20 ref	0.40 ref	0.90 ref

Part marking: No marking

All soldering surfaces to be coplanar within 0.1 millimeters

Tolerances are ±0.1 millimeters unless stated otherwise

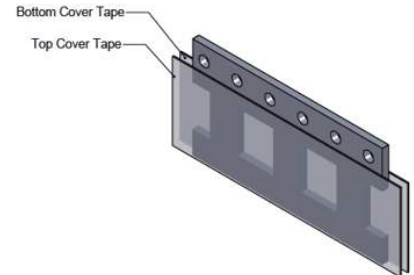
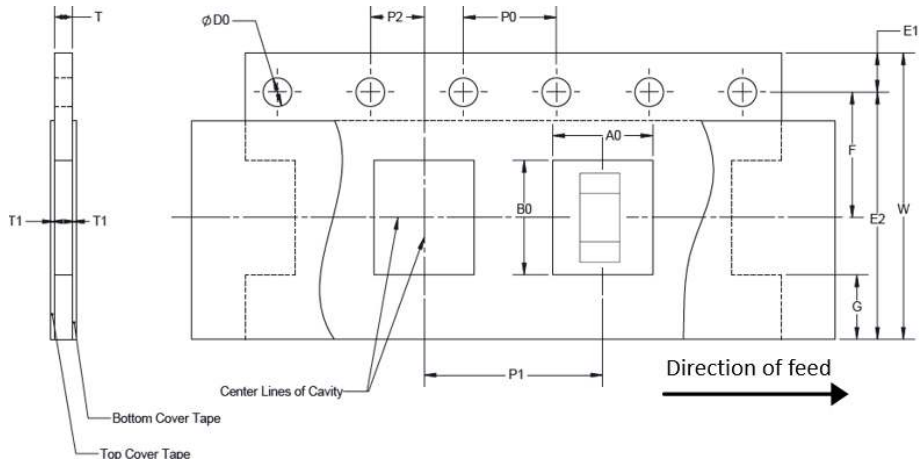
Pad layout dimensions are reference only

Traces or vias underneath the inductor is not recommended

**Packaging information (mm)**

Drawing not to scale

Supplied in tape and reel packaging, 4000 parts per 7" diameter reel

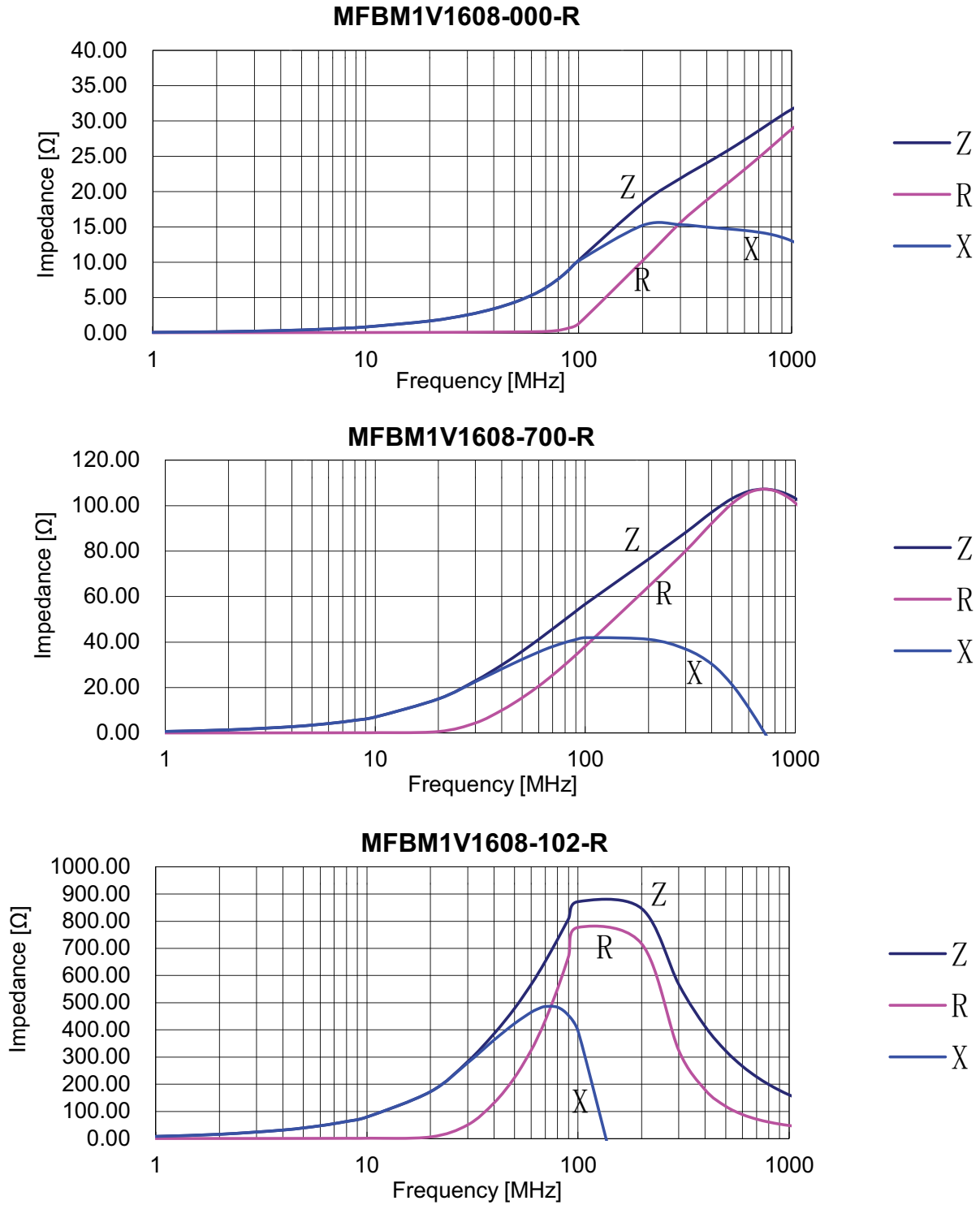


$W \pm 0.2$	8.00
$F \pm 0.1$	3.50
$E1 \pm 0.2$	1.75
E2 Min	na
$P0 \pm 0.2$	4.00
$P1 \pm 0.2$	4.00
$P2 \pm 0.1$	2.00
$D0 \pm 0.1$	1.55
A0	$1.1 \pm 0.2$
B0	$1.9 \pm 0.2$
T	$0.95 \pm 0.1$
T1 Max	na

**Qualification testing**

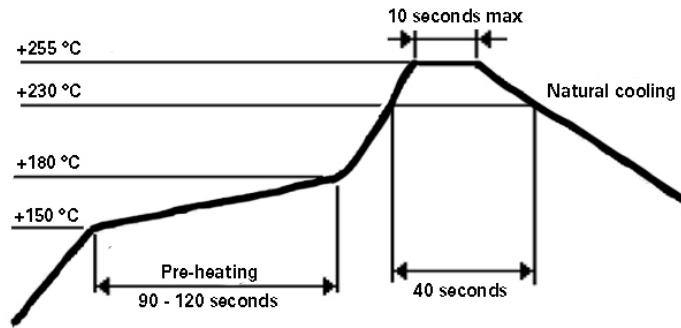
<b>No.</b>	<b>Test item</b>	<b>Sample size (pcs)</b>	<b>Test condition</b>	<b>Acceptable value/range</b>
1	External visual	72	Specification	No physical damage
2	Physical dimension	72	Specification	Specification
3	Initial electrical test	72	Specification	User specification
4	Solderability	6	+245 °C ±5 °C, dipping 5 ±1s	>95% solder coverage
5	Resistance to soldering heat	6	+260 ±5 °C for 10 ±1 s	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
6	Terminal strength (SMD)	6	Force of 5 N for 10 ±1 s	No physical damage No electrical performance test
7	Low temperature exposure	6	-55 °C for 1000 hours	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
8	Bending strength	6	Appendix 2 note: 2 mm, hold time 30 s (minimum)	No physical damage No electrical performance test
9	Drop	6	Drop 10 times to a concrete floor from a height of 1 m	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
10	Vibration	6	Amplitude modulation: 1.5 mm Test time: A period of 2 hours in each of 3 mutually perpendicular directions Test from 10 Hz to 55 Hz to 10 Hz for 1 minute	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
11	High temperature exposure	6	+125 °C for 1000 hours	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
12	Biased humidity	6	1000 hours +60 °C/90% to 95% RH unpowered	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
13	Operational life	12	+85 °C at rated current for 1000 hours	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage
14	Temperature cycling	6	32 cycles (-55 °C to +125 °C), dwell time 30 minutes	1. $\Delta Z/Z < \pm 30\%$ 2. No physical damage

Impedance vs frequency



Z= impedance, R= resistance, X= reactance

**Solder reflow profile**



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